onsemi

Hex Inverter MM74HCT04

General Description

The MM74HCT04 is a logic function fabricated by using advanced silicon–gate CMOS technology which provides the inherent benefits of CMOS—low quiescent power and wide power supply range. This device is input and output characteristic as well as pin–out compatible with standard 74LS logic families. The MM74HCT04, triple buffered, hex inverters, features low power dissipation and fast switching times. All inputs are protected from static discharge by internal diodes to V_{CC} and ground.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug–in replacements for LS–TTL devices and can be used to reduce power consumption in existing designs.

Features

- TTL, LS Pin-out and Threshold Compatible
- Fast Switching: t_{PLH}, t_{PHL} = 10 ns (typ.)
- Low Power: 10 µW at DC, 3.7 mW at 5 MHz
- High Fan Out: ≥10 LS Loads
- Inverting, Triple Buffered
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

Connection Diagram

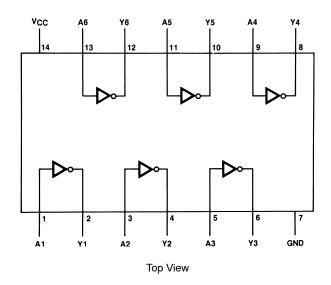
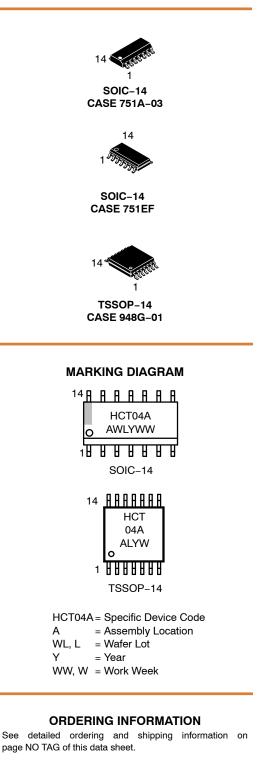


Figure 1. Pin Assignments for SOIC and TSSOP



ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Parameter		Rating	
V _{CC}	Supply Voltage		–0.5 to +7.0 V	
V _{IN}	DC Input Voltage		-0.5 to V _{CC} + 0.5 V	
V _{OUT}	DC Output Voltage		–0.5 to V _{CC} + 0.5 V	
I _{IK} , I _{OK}	Clamp Diode Current		±20 mA	
I _{OUT}	DC Output Current, per Pin		±25 mA	
I _{CC}	DC V _{CC} or GND Current, per Pin		±50 mA	
T _{STG}	Storage Temperature Range		–65°C to +150°C	
PD	Power Dissipation S.O. Package Only		500 mW	
ΤL	Lead Temperature (Soldering 10 Seconds)		260°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Max	Unit
V _{CC}	Supply Voltage	4.5	5.5	V
V _{IN} , V _{OUT}	DC Input or Output Voltage		V _{CC}	V
T _A	Operating Temperature Range		+125	°C
t _r , t _f	Input Rise or Fall Times		500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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Symbol	Parameter	Conditions	T _A = 25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C		
			Тур.	G	uaranteed Limit	ts	Unit
V _{IH}	Minimum HIGH Level Input Voltage		_	2.0	2.0	2.0	V
V_{IL}	Maximum LOW Level Input Voltage		_	0.8	0.8	0.8	V
V _{OH}	Minimum HIGH Level Output Voltage	V_{IN} = V_{IH} or V_{IL} , $ I_{OUT} $ = 20 μ A	V _{CC}	V _{CC} – 0.1	V _{CC} – 0.1	V _{CC} – 0.1	V
			4.2	3.98	3.84	3.7	
			5.2	4.98	4.84	4.7	
UL	Maximum LOW Level Voltage	V _{IN} = V _{IH} I _{OUT} = 20 μA	0	0.1	0.1	0.1	V
		$ \begin{array}{l} V_{IN} = V_{IH} \\ \mid I_{OUT} \mid = 4.0 \text{ mA} \\ V_{CC} = 4.5 \text{ V} \end{array} $	0.2	0.26	0.33	0.4	
			0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND, V_{IH} or V_{IL}	-	±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0 \ \mu A$	-	2.0	20	40	μA
		V _{IN} = 2.4 V or 0.5 V (Note 2)	-	0.3	0.4	0.5	mA

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5 V ±10% (unless otherwise specified))

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. This is measured per input with all other inputs held at V_{CC} or ground.

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AC ELECTRICAL CHARACTERISTICS

(V_{CC} = 5.0 V, $t_r = t_f = 6$ ns, C_L = 15 pF, T_A = 25°C (unless otherwise specified))

Symbol	Parameter	Conditions	Тур.	Guaranteed Limit	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay		10	18	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS

(V_{CC} = 5.0 V \pm 10%, t_r = t_f = 6 ns, C_L = 50 pF (unless otherwise specified))

			T _A = 25°C		T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	Conditions	Тур.	Gu	aranteed Lim	its	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay		14	20	25	30	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time		8	15	19	22	ns
C _{PD}	Power Dissipation Capacitance	(Note 3)	20	-	-	-	pF
C _{IN}	Input Capacitance		5	10	10	10	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. CPD determines the no load dynamic power consumption, PD = CPD VCC² f + ICC VCC, and the no load dynamic current consumption, $I_{\rm S} = C_{\rm PD} V_{\rm CC} f + I_{\rm CC}$.

ORDERING INFORMATION

Device	Package	Shipping [†]
MM74HCT04M	SOIC-14, Case 751A-03 (Pb-Free and Halide Free)	55 Units / Tube
MM74HCT04MX	SOIC-14, Case 751EF (Pb-Free and Halide Free)	2500 Units / Tape & Reel
MM74HCT04MTCX	TSSOP-14, Case 948G-01 (Pb-Free and Halide Free)	2500 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NOTE: All packages are lead free per JEDEC: J-STD-020B standard.

DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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SOIC14 CASE 751EF **ISSUE O** DATE 30 SEP 2016 8.75 8.50 Α 0.65 7.62 14 8 14 8 В 4.00 6.00 5.60 3.80 Ħ 1.70 7 **PIN #1** 1,27 7 0.51 **IDENT.** 1.27 0.35 (0.33) \oplus 0.25 (M) С В Α LAND PATTERN RECOMMENDATION TOP VIEW 1.75 MAX 0.25 С 0.19 0.10 С 1.50 0.25 0.10 1.25 SIDE VIEW **FRONT VIEW** NOTES: A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C **B. ALL DIMENSIONS ARE IN MILLIMETERS** 0.50 0.25 × 45° C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS LAND PATTERN STANDARD: R0.10 GAGE D. SOIC127P600X145-14M PLANE R0.10 E. CONFORMS TO ASME Y14.5M, 2009 0.36 8° 0° 0.90 0.50 SEATING PLANE (1.04)DETAIL A SCALE 16 : 1 Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98AON13739G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOIC14 PAGE 1 OF 1

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